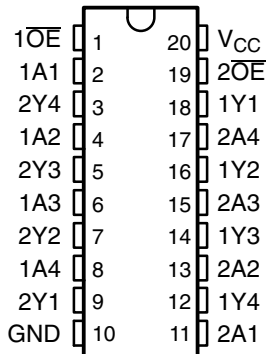


# SN54ACT240, SN74ACT240 OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

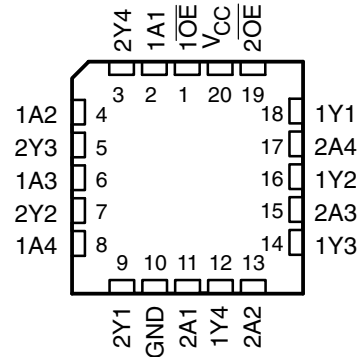
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- 4.5-V to 5.5-V  $V_{CC}$  Operation
- Inputs Accept Voltages to 5.5 V
- Max  $t_{pd}$  of 8.5 ns at 5 V
- Inputs Are TTL Compatible

SN54ACT240 . . . J OR W PACKAGE  
SN74ACT240 . . . DB, DW, N, NS, OR PW PACKAGE  
(TOP VIEW)



SN54ACT240 . . . FK PACKAGE  
(TOP VIEW)



## description/ordering information

These octal buffers and line drivers are designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

The 'ACT240 devices are organized as two 4-bit buffers/drivers with separate output-enable ( $\overline{OE}$ ) inputs. When  $\overline{OE}$  is low, the device passes inverted data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

## ORDERING INFORMATION

| $T_A$          | PACKAGE†      |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|---------------|---------------|-----------------------|------------------|
| -40°C to 85°C  | PDIP – N      | Tube          | SN74ACT240N           | SN74ACT240N      |
|                | SOIC – DW     | Tube          | SN74ACT240DW          | ACT240           |
|                |               | Tape and reel | SN74ACT240DWR         |                  |
|                | SOP – NS      | Tape and reel | SN74ACT240NSR         | ACT240           |
|                | SSOP – DB     | Tape and reel | SN74ACT240DBR         | AD240            |
| TSSOP – PW     | Tape and reel | SN74ACT240PWR | AD240                 |                  |
| -55°C to 125°C | CDIP – J      | Tube          | SNJ54ACT240J          | SNJ54ACT240J     |
|                | CFP – W       | Tube          | SNJ54ACT240W          | SNJ54ACT240W     |
|                | LCCC – FK     | Tube          | SNJ54ACT240FK         | SNJ54ACT240FK    |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

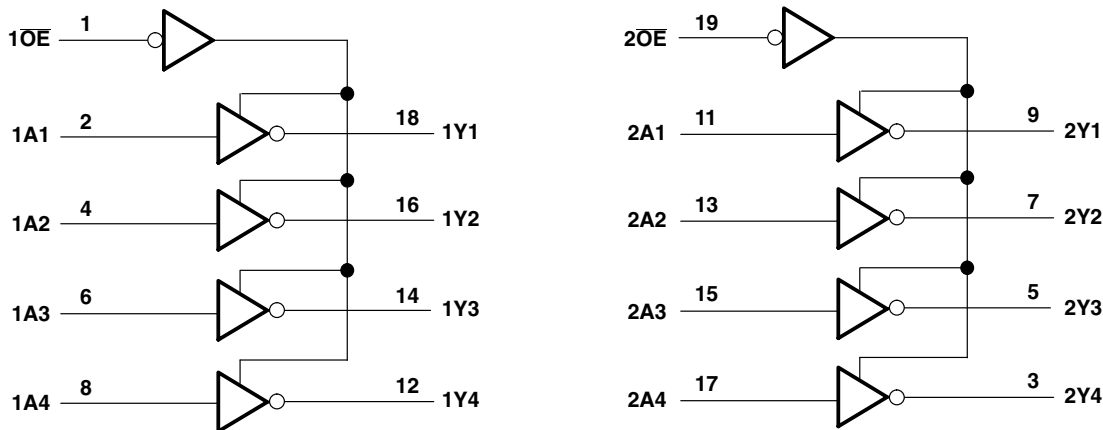
# SN54ACT240, SN74ACT240 OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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FUNCTION TABLE  
(each buffer)

| INPUTS |   | OUTPUT |
|--------|---|--------|
| OE     | A | Y      |
| L      | H | L      |
| L      | L | H      |
| H      | X | Z      |

## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|  |                            |
|--|----------------------------|
| Supply voltage range, $V_{CC}$                                 | -0.5 V to 7 V              |
| Input voltage range, $V_I$ (see Note 1)                        | -0.5 V to $V_{CC} + 0.5$ V |
| Output voltage range, $V_O$ (see Note 1)                       | -0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )  | $\pm 20$ mA                |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) | $\pm 20$ mA                |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )     | $\pm 50$ mA                |
| Continuous current through $V_{CC}$ or GND                     | $\pm 200$ mA               |
| Package thermal impedance, $\theta_{JA}$ (see Note 2):         |                            |
| DB package   | 70°C/W                     |
| DW package   | 58°C/W                     |
| N package  | 69°C/W                     |
| NS package   | 60°C/W                     |
| PW package   | 83°C/W                     |
| Storage temperature range, $T_{stg}$                           | -65°C to 150°C             |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51-7.

# SN54ACT240, SN74ACT240 OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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## recommended operating conditions (see Note 3)

|                     |                                    | SN54ACT240 |          | SN74ACT240 |          | UNIT |
|---------------------|------------------------------------|------------|----------|------------|----------|------|
|                     |                                    | MIN        | MAX      | MIN        | MAX      |      |
| $V_{CC}$            | Supply voltage                     | 4.5        | 5.5      | 4.5        | 5.5      | V    |
| $V_{IH}$            | High-level input voltage           | 2          |          | 2          |          | V    |
| $V_{IL}$            | Low-level input voltage            |            | 0.8      |            | 0.8      | V    |
| $V_I$               | Input voltage                      | 0          | $V_{CC}$ | 0          | $V_{CC}$ | V    |
| $V_O$               | Output voltage                     | 0          | $V_{CC}$ | 0          | $V_{CC}$ | V    |
| $I_{OH}$            | High-level output current          |            | -24      |            | -24      | mA   |
| $I_{OL}$            | Low-level output current           |            | 24       |            | 24       | mA   |
| $\Delta t/\Delta v$ | Input transition rise or fall rate |            | 8        |            | 8        | ns/V |
| $T_A$               | Operating free-air temperature     | -55        | 125      | -40        | 85       | °C   |

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                         | TEST CONDITIONS                                     | $V_{CC}$ | $T_A = 25^\circ\text{C}$ |       |            | SN54ACT240 |           | SN74ACT240    |     | UNIT |
|-----------------------------------|---|----------|--------------------------|-------|------------|------------|-----------|---------------|-----|------|
|                                   |   |          | MIN                      | TYP   | MAX        | MIN        | MAX       | MIN           | MAX |      |
| $V_{OH}$                          | $I_{OH} = -50 \mu\text{A}$                          | 4.5 V    | 4.4                      | 4.49  | 4.4        |            | 4.4       |               | V   |      |
|                                   |   | 5.5 V    | 5.4                      | 5.49  | 5.4        |            | 5.4       |               |     |      |
|                                   | $I_{OH} = -24 \text{ mA}$                           | 4.5 V    | 3.86                     |       | 3.7        |            | 3.76      |               |     |      |
|                                   |   | 5.5 V    | 4.86                     |       | 4.7        |            | 4.76      |               |     |      |
|                                   | $I_{OH} = -50 \text{ mA}^\dagger$                   | 5.5 V    |                          |       | 3.85       |            |           |               |     |      |
| $I_{OH} = -75 \text{ mA}^\dagger$ | 5.5 V   |          |                          |       |            | 3.85       |           |               |     |      |
| $V_{OL}$                          | $I_{OL} = 50 \mu\text{A}$                           | 4.5 V    |                          | 0.001 | 0.1        |            | 0.1       | 0.1           | V   |      |
|                                   |   | 5.5 V    |                          | 0.001 | 0.1        |            | 0.1       | 0.1           |     |      |
|                                   | $I_{OL} = 24 \text{ mA}$                            | 4.5 V    |                          |       | 0.36       |            | 0.5       | 0.44          |     |      |
|                                   |   | 5.5 V    |                          |       | 0.36       |            | 0.5       | 0.44          |     |      |
|                                   | $I_{OL} = 50 \text{ mA}^\dagger$                    | 5.5 V    |                          |       |            | 1.65       |           |               |     |      |
| $I_{OL} = 75 \text{ mA}^\dagger$  | 5.5 V   |          |                          |       |            |            | 1.65      |               |     |      |
| $I_{OZ}$                          | $V_O = V_{CC}$ or GND                               | 5.5 V    |                          |       | $\pm 0.25$ | $\pm 5$    | $\pm 2.5$ | $\mu\text{A}$ |     |      |
| $I_I$                             | $V_I = V_{CC}$ or GND                               | 5.5 V    |                          |       | $\pm 0.1$  | $\pm 1$    | $\pm 1$   | $\mu\text{A}$ |     |      |
| $I_{CC}$                          | $V_I = V_{CC}$ or GND, $I_O = 0$                    | 5.5 V    |                          |       | 4          | 80         | 40        | $\mu\text{A}$ |     |      |
| $\Delta I_{CC}^\ddagger$          | One input at 3.4 V, Other inputs at GND or $V_{CC}$ | 5.5 V    |                          | 0.6   |            | 1.6        | 1.5       | mA            |     |      |
| $C_i$                             | $V_I = V_{CC}$ or GND                               | 5 V      |                          | 2.5   |            |            |           | pF            |     |      |
| $C_o$                             | $V_I = V_{CC}$ or GND                               | 5 V      |                          | 8     |            |            |           | pF            |     |      |

$^\dagger$  Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

$^\ddagger$  This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or  $V_{CC}$ .

# SN54ACT240, SN74ACT240 OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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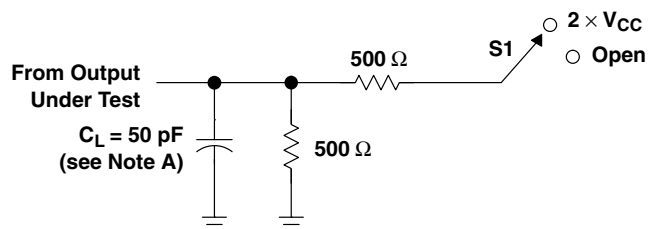
switching characteristics over recommended operating free-air temperature range,  $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT)    | TO (OUTPUT) | $T_A = 25^\circ\text{C}$ |     |     | SN54ACT240 |      | SN74ACT240 |      | UNIT |
|-----------|-----------------|-------------|--------------------------|-----|-----|------------|------|------------|------|------|
|           |                 |             | MIN                      | TYP | MAX | MIN        | MAX  | MIN        | MAX  |      |
| $t_{PLH}$ | A               | Y           | 1.5                      | 6   | 8.5 | 1          | 9.5  | 1.5        | 9.5  | ns   |
| $t_{PHL}$ |                 |             | 1.5                      | 5.5 | 7.5 | 1          | 9    | 1.5        | 8.5  |      |
| $t_{PZH}$ | $\overline{OE}$ | Y           | 1.5                      | 7   | 8.5 | 1          | 10   | 1          | 9.5  | ns   |
| $t_{PZL}$ |                 |             | 2                        | 7   | 9.5 | 1          | 11.5 | 1.5        | 10.5 |      |
| $t_{PHZ}$ | $\overline{OE}$ | Y           | 2                        | 8   | 9.5 | 1          | 11   | 2          | 10.5 | ns   |
| $t_{PLZ}$ |                 |             | 2.5                      | 6.5 | 10  | 1          | 11.5 | 2          | 10.5 |      |

operating characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

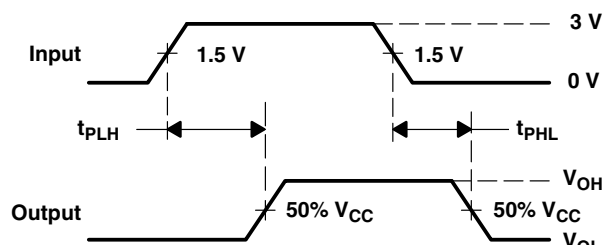
| PARAMETER  | TEST CONDITIONS                           | TYP | UNIT |
|--|---|-----|------|
| $C_{pd}$ Power dissipation capacitance per buffer/driver | $C_L = 50\text{ pF}$ , $f = 1\text{ MHz}$ | 45  | pF   |

## PARAMETER MEASUREMENT INFORMATION

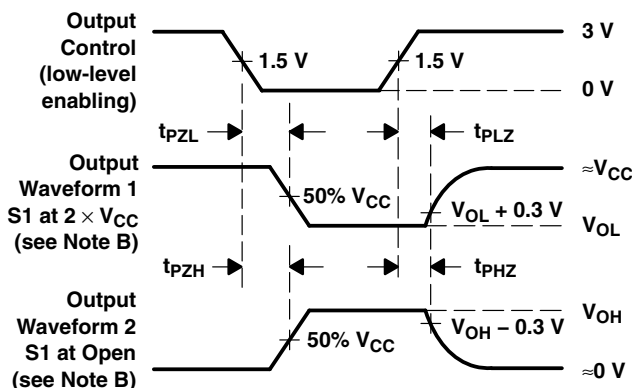


| TEST              | S1                |
|-------------------|-------------------|
| $t_{PLH}/t_{PHL}$ | Open              |
| $t_{PZL}/t_{PZL}$ | $2 \times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | Open              |

LOAD CIRCUIT



VOLTAGE WAVEFORMS







VOLTAGE WAVEFORMS

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2.5\text{ ns}$ ,  $t_f \leq 2.5\text{ ns}$ .  
 D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2)         | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)              | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-------------------------|-------------------------|----------------------|--------------|--------------------------------------|-------------------------|
| 5962-8775901M2A  | ACTIVE        | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE              | N / A for Pkg Type   | -55 to 125   | 5962-8775901M2A<br>SNJ54ACT<br>240FK | <a href="#">Samples</a> |
| 5962-8775901MRA  | ACTIVE        | CDIP         | J               | 20   | 1           | TBD                     | A42                     | N / A for Pkg Type   | -55 to 125   | 5962-8775901MR<br>A<br>SNJ54ACT240J  | <a href="#">Samples</a> |
| 5962-8775901MSA  | ACTIVE        | CFP          | W               | 20   | 1           | TBD                     | A42                     | N / A for Pkg Type   | -55 to 125   | 5962-8775901MS<br>A<br>SNJ54ACT240W  | <a href="#">Samples</a> |
| SN74ACT240DBLE   | OBSOLETE      | SSOP         | DB              | 20   |             | TBD                     | Call TI                 | Call TI              | -40 to 85    |                                      |                         |
| SN74ACT240DBR    | ACTIVE        | SSOP         | DB              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 85    | AD240                                | <a href="#">Samples</a> |
| SN74ACT240DW     | ACTIVE        | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 85    | ACT240                               | <a href="#">Samples</a> |
| SN74ACT240DWE4   | ACTIVE        | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 85    | ACT240                               | <a href="#">Samples</a> |
| SN74ACT240DWG4   | ACTIVE        | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 85    | ACT240                               | <a href="#">Samples</a> |
| SN74ACT240DWR    | ACTIVE        | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 85    | ACT240                               | <a href="#">Samples</a> |
| SN74ACT240DWRE4  | ACTIVE        | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 85    | ACT240                               | <a href="#">Samples</a> |
| SN74ACT240N      | ACTIVE        | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU               | N / A for Pkg Type   | -40 to 85    | SN74ACT240N                          | <a href="#">Samples</a> |
| SN74ACT240NSR    | ACTIVE        | SO           | NS              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 85    | ACT240                               | <a href="#">Samples</a> |
| SN74ACT240PW     | ACTIVE        | TSSOP        | PW              | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 85    | AD240                                | <a href="#">Samples</a> |
| SN74ACT240PWG4   | ACTIVE        | TSSOP        | PW              | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 85    | AD240                                | <a href="#">Samples</a> |
| SN74ACT240PWLE   | OBSOLETE      | TSSOP        | PW              | 20   |             | TBD                     | Call TI                 | Call TI              | -40 to 85    |                                      |                         |
| SN74ACT240PWR    | ACTIVE        | TSSOP        | PW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU   CU SN       | Level-1-260C-UNLIM   | -40 to 85    | AD240                                | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2)         | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)              | Samples   |
|------------------|---------------|--------------|-----------------|------|-------------|-------------------------|-------------------------|----------------------|--------------|--------------------------------------|---|
| SN74ACT240PWRG4  | ACTIVE        | TSSOP        | PW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 85    | AD240                                |  |
| SNJ54ACT240FK    | ACTIVE        | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE              | N / A for Pkg Type   | -55 to 125   | 5962-8775901M2A<br>SNJ54ACT<br>240FK |  |
| SNJ54ACT240J     | ACTIVE        | CDIP         | J               | 20   | 1           | TBD                     | A42                     | N / A for Pkg Type   | -55 to 125   | 5962-8775901MR<br>A<br>SNJ54ACT240J  |  |
| SNJ54ACT240W     | ACTIVE        | CFP          | W               | 20   | 1           | TBD                     | A42                     | N / A for Pkg Type   | -55 to 125   | 5962-8775901MS<br>A<br>SNJ54ACT240W  |  |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF SN54ACT240, SN74ACT240 :**

- Catalog: [SN74ACT240](#)
- Military: [SN54ACT240](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74ACT240DBR | SSOP         | DB              | 20   | 2000 | 330.0              | 16.4               | 8.2     | 7.5     | 2.5     | 12.0    | 16.0   | Q1            |
| SN74ACT240DWR | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| SN74ACT240NSR | SO           | NS              | 20   | 2000 | 330.0              | 24.4               | 8.2     | 13.0    | 2.5     | 12.0    | 24.0   | Q1            |
| SN74ACT240PWR | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |
| SN74ACT240PWR | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ACT240DBR | SSOP         | DB              | 20   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74ACT240DWR | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74ACT240NSR | SO           | NS              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74ACT240PWR | TSSOP        | PW              | 20   | 2000 | 364.0       | 364.0      | 27.0        |
| SN74ACT240PWR | TSSOP        | PW              | 20   | 2000 | 367.0       | 367.0      | 38.0        |



W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within Mil-Std 1835 GDFP2-F20

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



| NO. OF TERMINALS ** | A                |                  | B                |                  |
|---------------------|------------------|------------------|------------------|------------------|
|                     | MIN              | MAX              | MIN              | MAX              |
| 20                  | 0.342<br>(8,69)  | 0.358<br>(9,09)  | 0.307<br>(7,80)  | 0.358<br>(9,09)  |
| 28                  | 0.442<br>(11,23) | 0.458<br>(11,63) | 0.406<br>(10,31) | 0.458<br>(11,63) |
| 44                  | 0.640<br>(16,26) | 0.660<br>(16,76) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 52                  | 0.740<br>(18,78) | 0.761<br>(19,32) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 68                  | 0.938<br>(23,83) | 0.962<br>(24,43) | 0.850<br>(21,6)  | 0.858<br>(21,8)  |
| 84                  | 1.141<br>(28,99) | 1.165<br>(29,59) | 1.047<br>(26,6)  | 1.063<br>(27,0)  |



4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - Falls within JEDEC MS-004

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G20)

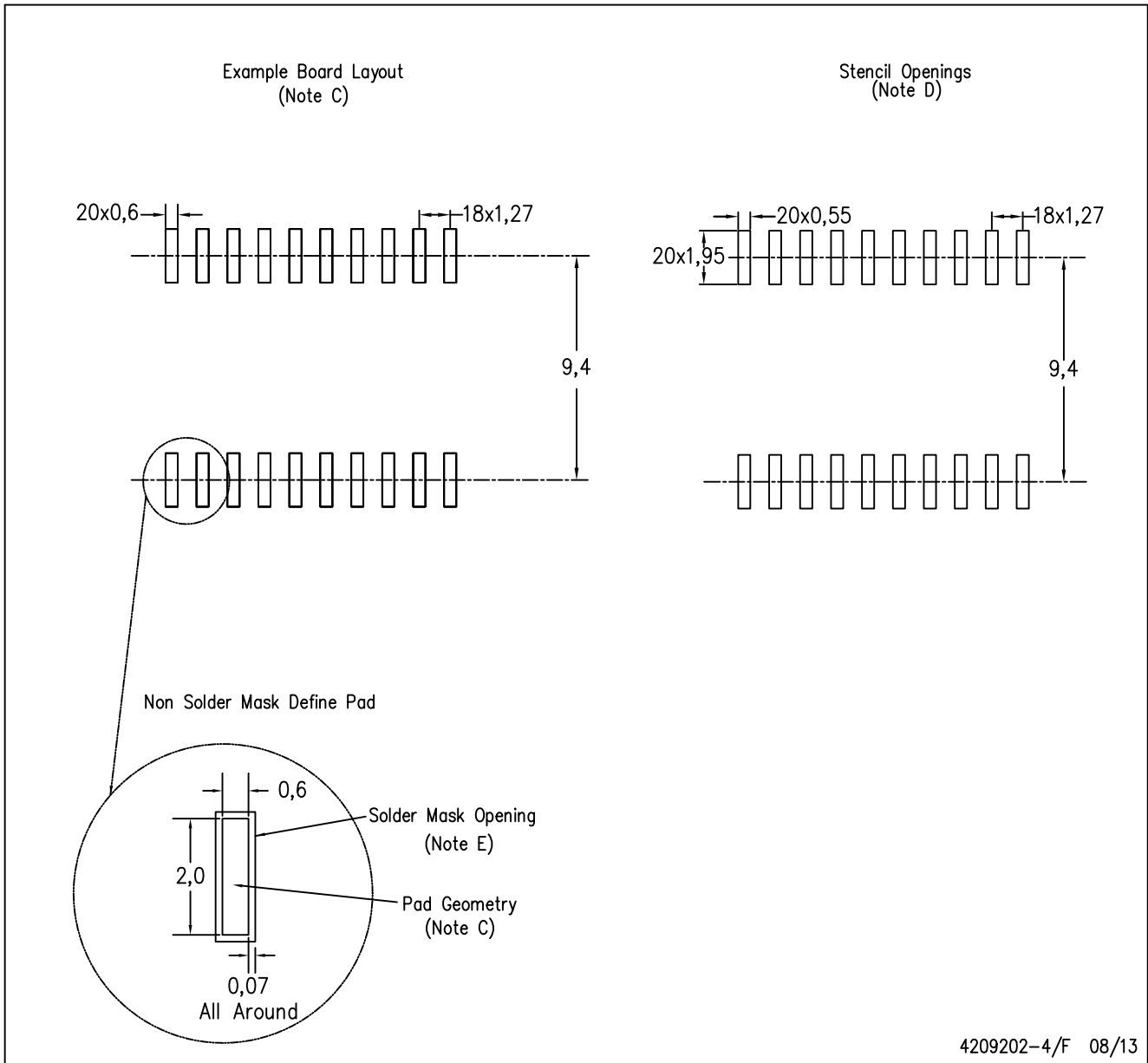
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-013 variation AC.

DW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Refer to IPC7351 for alternate board design.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate design.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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|                               |  |
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| Consumer Electronics          | <a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>                   |
| Energy and Lighting           | <a href="http://www.ti.com/energy">www.ti.com/energy</a>                                 |
| Industrial                    | <a href="http://www.ti.com/industrial">www.ti.com/industrial</a>                         |
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